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PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

CONVEYING PARTY DATA

Name	Execution Date
HISASHI HANAZAKI	02/13/2015

RECEIVING PARTY DATA

Name:	YAZAKI CORPORATION	
Street Address:	4-28, MITA 1-CHOME, MINATO-KU	
City:	TOKYO	
State/Country:	JAPAN	
Postal Code:	108-8333	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14629697

CORRESPONDENCE DATA

Fax Number: (202)293-7860

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 202-293-7060

Email: sughrue@sughrue.com, icontreras@sughrue.com

Correspondent Name: SUGHRUE MION, PLLC

Address Line 1: 2100 PENNSYLVANIA AVE. NW SUITE 800

Address Line 4: WASHINGTON, D.C. 20037-3213

ATTORNEY DOCKET NUMBER:	Q218014	
NAME OF SUBMITTER:	INGRID CONTRERAS, TEAMS DEPT.	
SIGNATURE:	/Ingrid Contreras/	
DATE SIGNED:	NED: 02/24/2015	
	This document serves as an Oath/Declaration (37 CFR 1.63).	

Total Attachments: 2

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PATENT 503191758 REEL: 035013 FRAME: 0941

Docket No.: Only After Sept 16, 2012 Claiming Foreign Priority

ASSIGNMENT WITH DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION (37 CFR 1.63)

Whereas, I/We, the undersigned inventor(s) hereinafter called assignor(s), have invented certain improvements described in the application identified below; and

Whereas, YAZAKI CORPORATION of 4-28. Mita 1-chome, Minato-ku, Tokyo 108-8333 Japan, (assignee), desires to acquire the entire right, title, and interest in the application and invention, and to any United States patents to be obtained therefor,

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,

I/We, the above named assignor(s), hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including all divisions, and continuations thereof, and all Letters Patent of the United States that may be granted thereon, and all reissues thereof, including the right to claim priority under 35 USC 119, and I/we request the Director of the U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns, and I/we will execute without further consideration all papers deemed necessary by the assignee in connection with the United States application when called upon to do so by the assignee.

(Legalization not required for recording but is prima facie evidence of execution under 35 USC 261)

As the below named inventor, I her	by declare that:	
This assignment with declaration is lirected to:	■ The attached application, or	
	United States Application or PCT International Application Number	í
de Milhelm Millianie (1.	filed on(Confirmation No).	٠,
The application is entitled:		ď
	TITUTOTH DIAM CEDCULA	÷

FLEXIBLE FLAT CIRCUIT

The above identified application was made or was authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I have reviewed and understand the contents of the application for which this assignment with declaration is being submitted.

I am aware of the duty to disclose to the Office all information known to me to be material to patentability as defined in 37 CFR 1.56.

I hereby acknowledge that any willful false statement made in this assignment with declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both.

Authorization To Permit Access To Application by Participating Office

☑ If checked, the undersigned hereby grants the USPTO authority to provide the European Patent Office (EPO), the Japan Patent Office (JPO), the Korean Intellectual Property Office (KIPO), the World Intellectual Property Office (WIPO), and any other intellectual property offices in which a foreign application claiming priority to the above-identified application is filed access to the above-identified patent application. See 37 CFR 1.14(c) and (h). This box should not be checked if the applicant does not wish the EPO, JPO, KIPO, or other intellectual property office in which a foreign application claiming priority to the above-identified application is filed to have access to the application.

In accordance with 37 CFR 1.14(h)(3), access will be provided to a copy of the application-as-filed with respect to: 1) the above-identified patent application-as-filed, 2) any foreign application to which the above-identified application claims priority under 35 USC 119(a)-(d) if a copy of the foreign application that satisfies the certified copy requirement of 37 CFR 1.55 has been filed in the above-identified patent application, and 3) any U.S. application-as-filed from which benefit is sought in the above-identified patent application.

In accordance with 37 CFR 1.14(c), access may be provided to information concerning the date of filing the Authorization to Permit Access to Application by Participating Office.

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MANAGE		
NAME OF SOLE OR FIRST INVENTOR:		
Given Name		
(first and middle [if any]) Hisashi	Family Name or Surname HANAZAKI	
Inventor's signature Hisashi Hanaza	1 Date Feb. 13.2015	
Residence: Susono-shi, Shizuoka, Japan		
= 2		
Mailing Address: c/o Yazaki Parts Co., Ltd., 1500, Mishuku, Susono-	-shi, Shizuoka, Japan	
NAME OF SECOND INVENTOR:		
Given Name		
(first and middle [if any])	Family Name or Surname	
Inventor's signature	Date	
Residence:		
Mailing Address:		
NAME OF THIRD INVENTOR:		
Given Name (first and middle [if any])	Family Name or Surname	
This and middle in any)	Tathiry Name of Sumane	
Inventor's signature		
inventor's signature	Date	
Residence:		
Residence:		
Mailing Address:		
NAME OF FOURTH INVENTOR:		
Given Name	다	
(first and middle [if any])	Family Name or Surname	
Inventor's signature	Date Date	
Residence:		
Mailing		
Address:		
NAME OF FIFTH INVENTOR:		
Given Name		
(first and middle [if any])	Family Name or Surname	
Inventor's signature	Date	
Residence:		
Mailing		
Address		

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